

## N-Channel Enhancement Mode MOSFET

### 1. Product Information

#### 1.1 Features

- ☒ Surface-mounted package
- ☒ Advanced trench cell design
- ☒ Super Trench

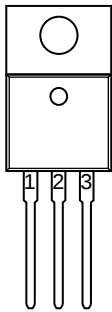
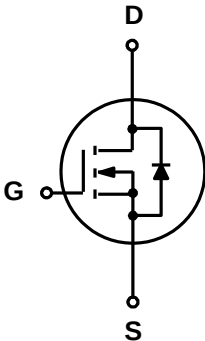
#### 1.2 Applications

- ☒ BMS appliances
- ☒ High power inverter system
- ☒ Power appliances

#### 1.3 Quick reference

- ☒  $BV \geq 85\text{ V}$
- ☒  $R_{DS(ON)} \leq 2.8\text{ m}\Omega @ V_{GS} = 10\text{ V}$
- ☒  $P_{tot} \leq 158\text{ W}$
- ☒  $I_D \leq 238\text{ A}$

### 2. Pin Description

| Pin | Description | Simplified Outline                                                                                        | Symbol                                                                                |
|-----|-------------|-----------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------|
| 1   | Gate(G)     | <br>Top View<br>TO-220 |  |
| 2   | Drain(D)    |                                                                                                           |                                                                                       |
| 3   | Source(S)   |                                                                                                           |                                                                                       |

## 3. Limiting Values

| Symbol             | Parameter                               | Conditions                                               | Min | Max      | Unit                 |
|--------------------|-----------------------------------------|----------------------------------------------------------|-----|----------|----------------------|
| $V_{DS}$           | Drain-Source Voltage                    | $T_C = 25\text{ }^{\circ}\text{C}$                       | 85  | -        | V                    |
| $V_{GS}$           | Gate-Source Voltage                     | $T_C = 25\text{ }^{\circ}\text{C}$                       | -   | $\pm 20$ | V                    |
| $I_{D^{***}}$      | Drain Current ( DC )                    | $T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$ | -   | 238      | A                    |
| $I_{DM^{***,***}}$ | Drain Current ( Pulsed )                | $T_C = 25\text{ }^{\circ}\text{C}, V_{GS} = 10\text{ V}$ | -   | 900      | A                    |
| $P_{tot}^*$        | Drain power dissipation                 | $T_C = 25\text{ }^{\circ}\text{C}$                       | -   | 158      | W                    |
| $T_{stg}$          | Storage Temperature                     |                                                          | -55 | 150      | $^{\circ}\text{C}$   |
| $T_J$              | Junction Temperature                    |                                                          | -   | 150      | $^{\circ}\text{C}$   |
| $I_S$              | Continuous-Source Current               | $T_C = 25\text{ }^{\circ}\text{C}$                       | -   | 240      | A                    |
| $E_{AS}^*$         | Single Pulsed Avalanche Energy          | $V_{DD}=50\text{ V}, L=0.1\text{ mH}$                    | -   | 900      | mJ                   |
| $R_{\theta JA}^*$  | Thermal Resistance- Junction to Ambient |                                                          | -   | 62.5     | $^{\circ}\text{C/W}$ |
| $R_{\theta JC}^*$  | Thermal Resistance- Junction to Case    |                                                          | -   | 0.8      |                      |

Notes :

\* Surface Mounted on 1 in<sup>2</sup> pad area,  $t \leq 10\text{ sec}$

\*\* Pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$

\*\*\* Limited by bonding wire

## 4. Marking Information

| Product Name | Marking                                             |
|--------------|-----------------------------------------------------|
| KJ2R5N08C    | <div>2R5N08</div> <div>YWWXXX :<br/>Date Code</div> |

## 5. Ordering Code

| Product Name | Package | Reel Size | Tape width | Quantity | Note |
|--------------|---------|-----------|------------|----------|------|
| KJ2R5N08C    | TO-220  |           |            | 50       |      |

Note: KUAJIEXIN defines " Green " as lead-free ( RoHS compliant ) and halogen free ( Br or Cl does not exceed 900 ppm by weight in homogeneous material and total of Br and Cl does not exceed 1500 ppm by weight; Follow IEC 61249-2-21 and IPC / JEDEC J-STD-020C )

## 6. Electrical Characteristics ( $T_A=25^\circ$ Unless Otherwise Noted )

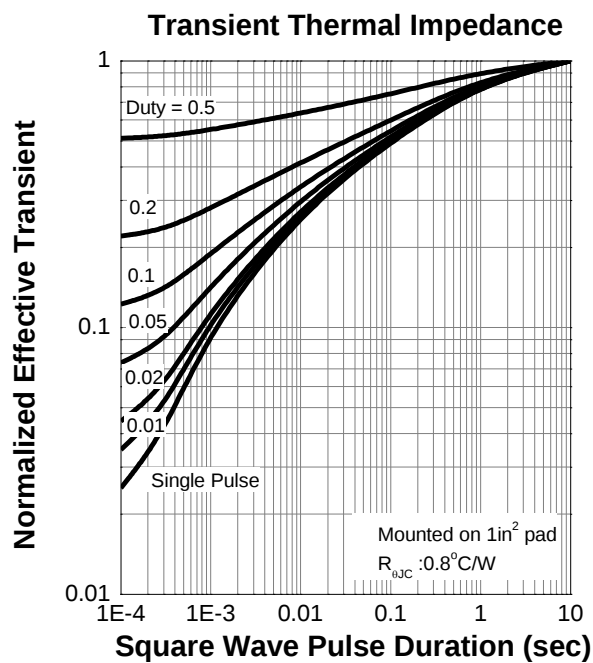
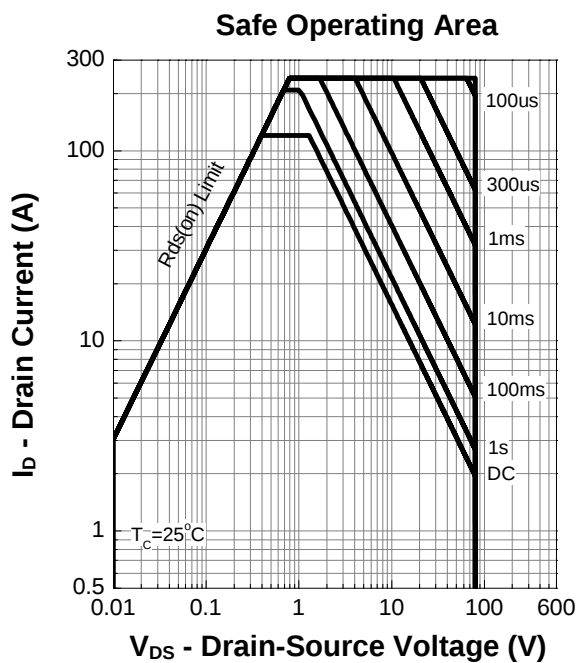
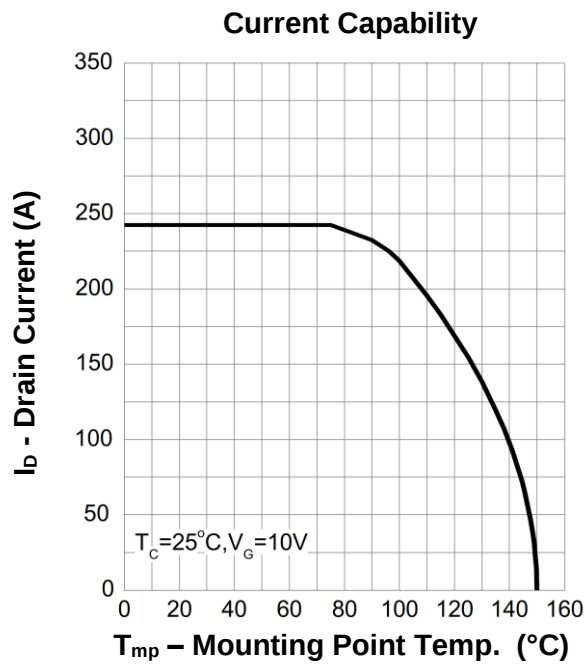
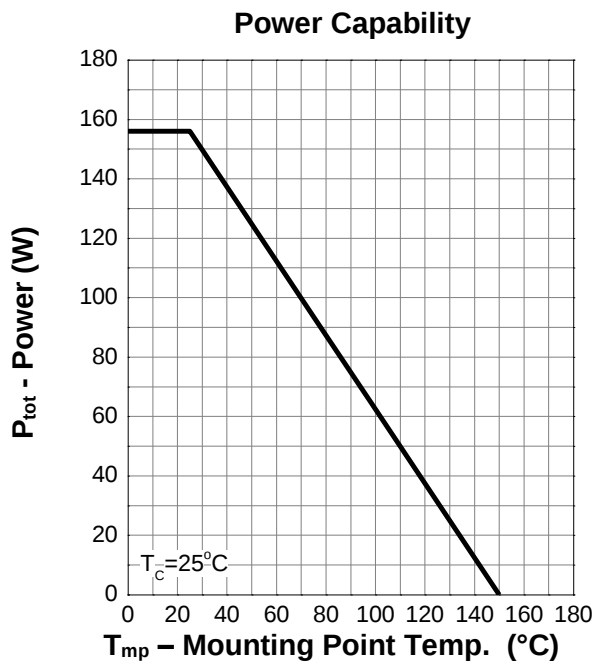
| Symbol                                   | Parameter                      | Conditions                                                                                                                    | Min | Typ  | Max  | Unit |
|------------------------------------------|--------------------------------|-------------------------------------------------------------------------------------------------------------------------------|-----|------|------|------|
| Static Characteristics                   |                                |                                                                                                                               |     |      |      |      |
| BV <sub>DSS</sub>                        | Drain-Source Breakdown Voltage | V <sub>GS</sub> = 0 V, I <sub>DS</sub> = 250 μA                                                                               | 85  | 97   | -    | V    |
| V <sub>GS(th)</sub>                      | Gate Threshold Voltage         | V <sub>DS</sub> = V <sub>GS</sub> , I <sub>DS</sub> = 250 μA                                                                  | 2   | -    | 4    | V    |
| I <sub>DSS</sub>                         | Drain Leakage Current          | V <sub>DS</sub> = 64 V, V <sub>GS</sub> = 0 V                                                                                 | -   | -    | 1    | μA   |
|                                          |                                | T <sub>J</sub> = 85 °C                                                                                                        | -   | -    | 30   | μA   |
| I <sub>GSS</sub>                         | Gate Leakage Current           | V <sub>GS</sub> = 0 V, V <sub>GS</sub> = ± 20 V                                                                               | -   | -    | ±100 | nA   |
| R <sub>DS(ON)</sub> <sup>a</sup>         | On-State Resistance            | V <sub>GS</sub> = 10 V, I <sub>DS</sub> = 30 A                                                                                | -   | 2.5  | 2.8  | mΩ   |
| Diode Characteristics                    |                                |                                                                                                                               |     |      |      |      |
| V <sub>SD</sub> <sup>a</sup>             | Diode Forward Voltage          | I <sub>SD</sub> = 30 A, V <sub>GS</sub> = 0 V                                                                                 | -   | -    | 1.3  | V    |
| t <sub>rr</sub>                          | Reverse Recovery Time          | I <sub>DS</sub> = 30 A, V <sub>GS</sub> = 0 V<br>dI <sub>SD</sub> /dt = 100 A/μs                                              | -   | 62   | -    | nS   |
| Q <sub>rr</sub>                          | Reverse Recovery Charge        |                                                                                                                               | -   | 83   | -    | nC   |
| Dynamic Characteristics <sup>b</sup>     |                                |                                                                                                                               |     |      |      |      |
| C <sub>iss</sub>                         | Input Capacitance              | V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 40 V<br>Frequency = 1 MHz                                                            | -   | 5591 | -    | pF   |
| C <sub>oss</sub>                         | Output Capacitance             |                                                                                                                               | -   | 744  | -    |      |
| C <sub>rss</sub>                         | Reverse Transfer Capacitance   |                                                                                                                               | -   | 75   | -    |      |
| t <sub>d(on)</sub>                       | Turn-on Delay Time             | V <sub>DS</sub> = 40 V, V <sub>GEN</sub> = 10 V,<br>R <sub>G</sub> = 4.5 Ω, R <sub>L</sub> = 1.3 Ω,<br>I <sub>DS</sub> = 30 A | -   | 23   | -    | nS   |
| t <sub>r</sub>                           | Turn-on Rise Time              |                                                                                                                               | -   | 65   | -    |      |
| t <sub>d(off)</sub>                      | Turn-off Delay Time            |                                                                                                                               | -   | 71   | -    |      |
| t <sub>f</sub>                           | Turn-off Fall Time             |                                                                                                                               | -   | 73   | -    |      |
| Gate Charge Characteristics <sup>b</sup> |                                |                                                                                                                               |     |      |      |      |
| Q <sub>g</sub>                           | Total Gate Charge              | V <sub>DS</sub> = 40 V, V <sub>GS</sub> = 10 V,<br>I <sub>DS</sub> = 30 A                                                     | -   | 101  | -    | nC   |
| Q <sub>gs</sub>                          | Gate-Source Charge             |                                                                                                                               | -   | 28   | -    |      |
| Q <sub>gd</sub>                          | Gate-Drain Charge              |                                                                                                                               | -   | 25   | -    |      |

Notes :

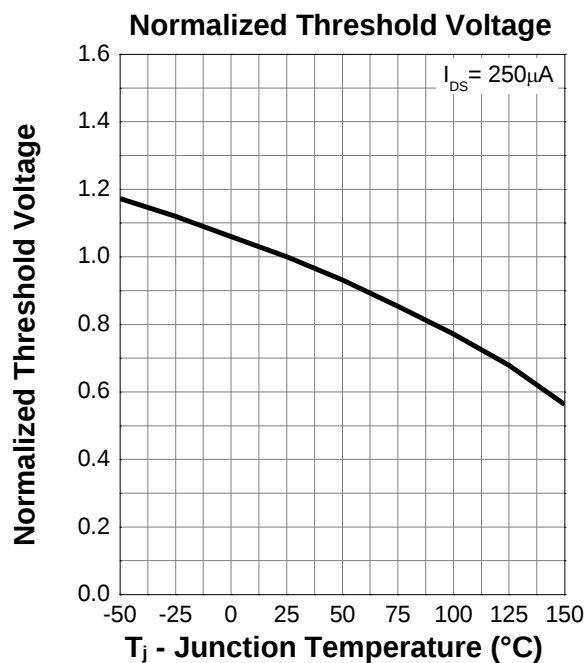
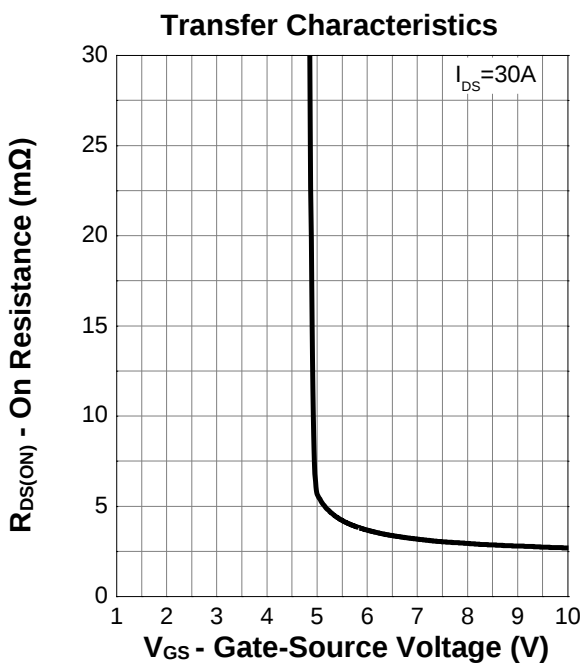
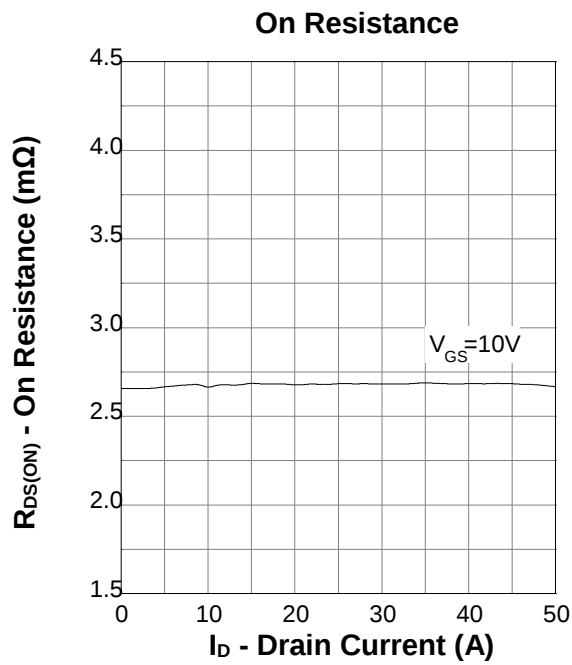
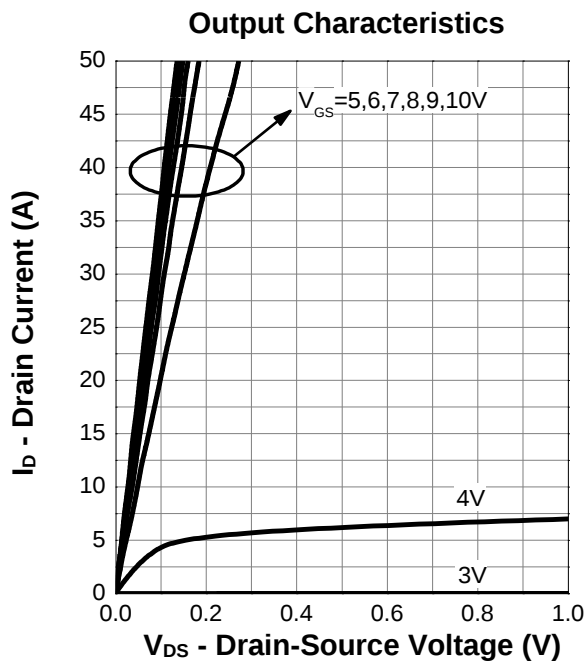
a : Pulse test ; pulse width  $\leq 300\text{ }\mu\text{s}$ , duty cycle  $\leq 2\%$

b : Guaranteed by design, not subject to production testing

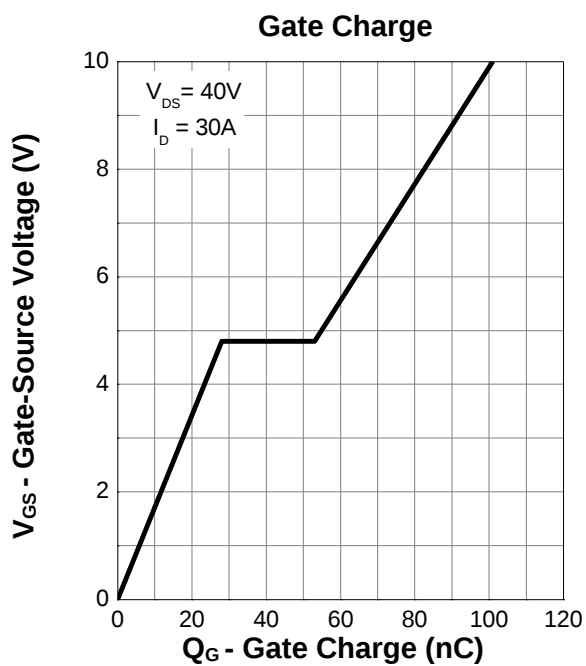
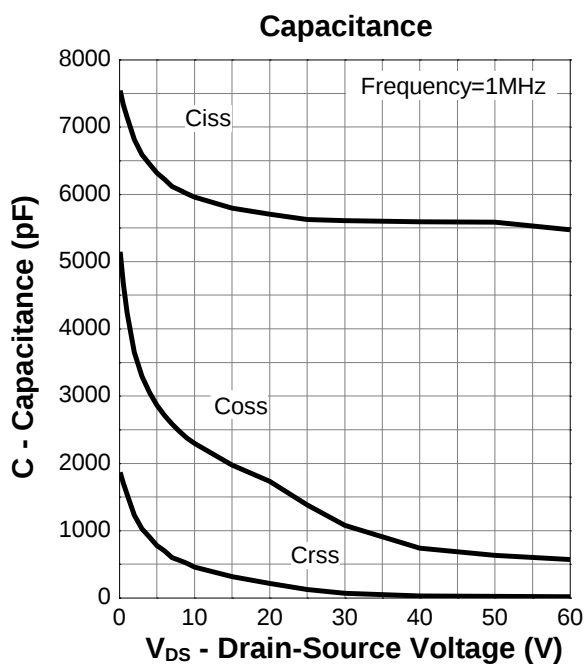
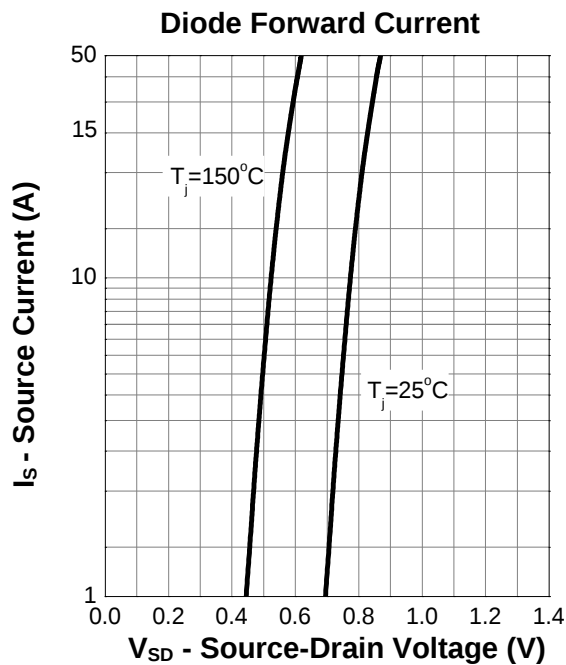
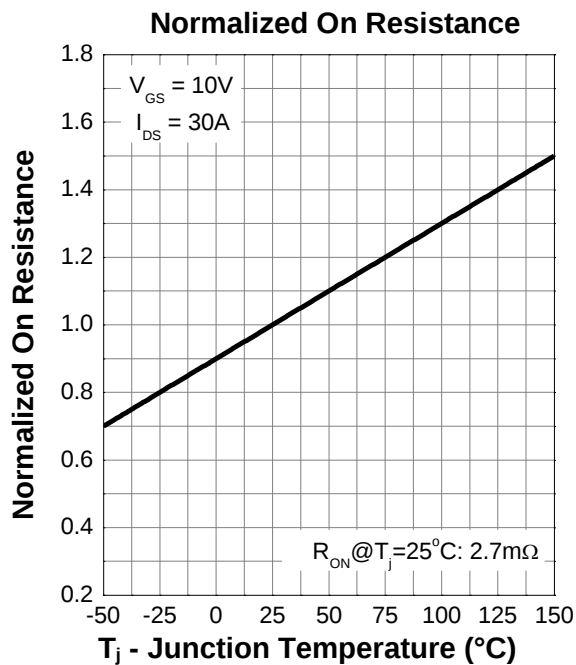
## 7. Typical Characteristics



## 7. Typical Characteristics (cont.)

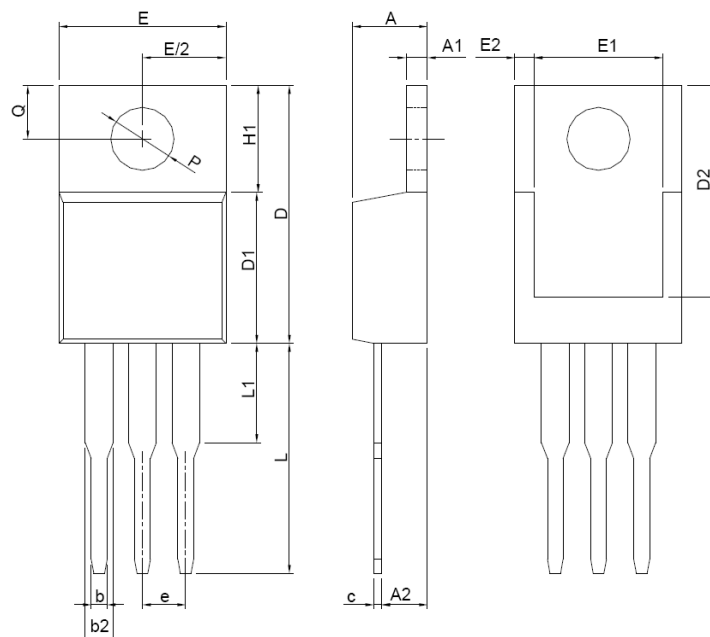


## 7. Typical Characteristics (cont.)



## 8.Package Dimensions

### TO-220 Package



| Symbol | Dimensions In Millimeters |       |
|--------|---------------------------|-------|
|        | MIN.                      | MAX.  |
| A      | 3.56                      | 4.83  |
| A1     | 0.51                      | 1.40  |
| A2     | 2.03                      | 2.92  |
| b      | 0.38                      | 1.02  |
| b2     | 1.14                      | 1.78  |
| c      | 0.36                      | 0.61  |
| D      | 14.22                     | 16.51 |
| D1     | 8.38                      | 9.02  |
| D2     | 12.19                     | 12.88 |
| E      | 9.65                      | 10.67 |
| E1     | 6.86                      | 8.89  |
| E2     | 0.76BSC                   |       |
| e      | 2.54BSC                   |       |
| H1     | 5.84                      | 6.86  |
| L      | 12.70                     | 14.73 |
| L1     | 6.35BSC                   |       |
| P      | 3.53                      | 4.09  |
| Q      | 2.54                      | 3.43  |